



# Helixeon - Color Series



Helixeon, a solid-state lighting device, provides high luminous flux output with high efficiency. Helixeon is encapsulated in silicone by molding technology. Also, Helixeon is capable of standard lead free solder reflow process. The standard color product line includes red, green, blue, amber, cyan, and etc.

# **Features**

- High luminous flux output
- Long life operation
- Instant response
- RoHS certification
- Superior ESD protection
- Silicone molding lens

# **Application**

- Decoration lighting
- Architectural lighting
- Stage lighting
- General lighting





# **■ Product Nomenclature**

X1		X2		X3		X4	
Item		Mode		Heat sink		Power	
Code	Type	Code	Type	Code	Type	Code	Type
HM	Molding	HP	High power	E	Emitter	1	1W

X5		X6	
Lens		Color	
Code	Type	Code	Type
L	Lambertian	R	Red
Н	Lambertian II	A	Amber
F	Focusing	G	Green
В	Batwing	В	Blue
		C	Cyan

# **Circuit Diagram of Helixeon Emitter**

Color	Part number	Circuit diagram
Red	HMHP-E1LR \ HMHP-E1FR	O(-) cathode
	HMHP-E1BR \ HMHP-E1HR	
Amber	HMHP-E1LA · HMHP-E1FA	7 4
	HMHP-E1BA · HMHP-E1HA	anode (+) Heatsink
Green	HMHP-E1LG \ HMHP-E1FG	O(-) cathode
	HMHP-E1BG \ HMHP-E1HG	
Blue	HMHP-E1LB · HMHP-E1FB	4 4
	HMHP-E1BB \ HMHP-E1HB	
Cyan	HMHP-E1LC	<b>o</b> (+) anode

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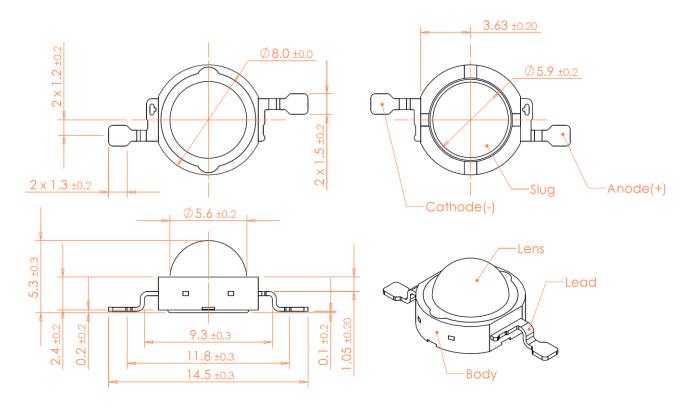
2



# **■ Package Dimensions**

# **SMT Lead Form**

#### Lambertian

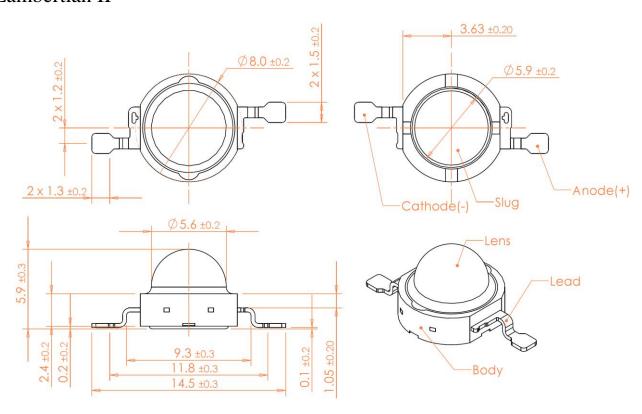


#### Note:

- 1. The anode side of the device is denoted by a hole in the lead frame.
- 2. Electrical insulation between the case and the board is required. The slug of the device is no electrically neutral.
- 3. Drawings are not to scale.
- 4. All dimensions are all in millimeter.
- 5. All dimensions without tolerance are for reference only.
- 6. Specifications are subject to change without notice.



### Lambertian II



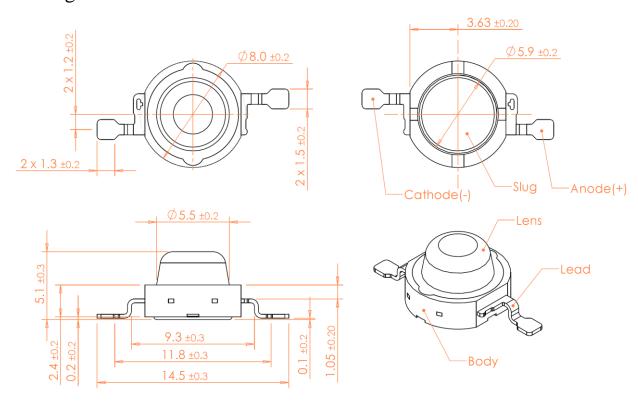
#### **Note:**

- 1. The anode side of the device is denoted by a hole in the lead frame.
- 2. Electrical insulation between the case and the board is required. The slug of the device is no electrically neutral.
- 3. Drawings are not to scale.
- 4. All dimensions are all in millimeter.
- 5. All dimensions without tolerance are for reference only.
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# **Batwing**



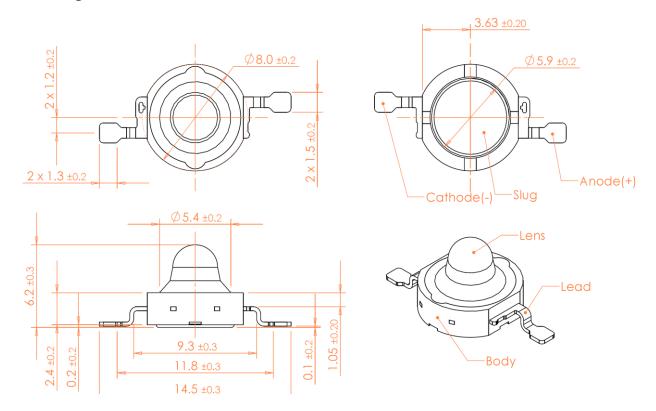
#### **Note:**

- 1. The anode side of the device is denoted by a hole in the lead frame.
- 2. Electrical insulation between the case and the board is required. The slug of the device is no electrically neutral.
- 3. Drawings are not to scale.
- 4. All dimensions are all in millimeter.
- 5. All dimensions without tolerance are for reference only.
- 6. Specifications are subject to change without notice.





# Focusing



#### Note:

- 1. The anode side of the device is denoted by a hole in the lead frame.
- 2. Electrical insulation between the case and the board is required. The slug of the device is no electrically neutral.
- 3. Drawings are not to scale.
- 4. All dimensions are all in millimeter.
- 5. All dimensions without tolerance are for reference only.
- 6. Specifications are subject to change without notice.



# **■** Characteristics for Helixeon emitter

# <u>HMHP-E1LR</u> · <u>HMHP-E1FR</u> · <u>HMHP-E1BR</u> · <u>HMHP-E1HR</u>

Characteristics at If = 350mA (Ta=25°C):

Do no ma esta m	Cryssh ol	Value			Unit
Parameter	Symbol	Min	Typical	Max	
Luminous flux <sup>(1)</sup>	Φ <sub>v</sub> <sup>(2)</sup>	45	50		lm
Dominant Wavelength (3)	Wd	610		630	nm
View angle (Lambertian)			150		
View angle (Lambertian II)			140		
View angle (Focusing)	2Θ <sub>1/2</sub>		75		degree
View angle (Batwing)			140		
Forward Voltage (4)	V <sub>F</sub>	2.0		3.0	V
Power dissipation	P <sub>D</sub>	0.7		1.05	W

# HMHP-E1LA · HMHP-E1FA · HMHP-E1BA · HMHP-E1HA

Characteristics at  $I_F = 350 \text{mA}$  (Ta=25°C):

Downwoton	Value				Unit
Parameter	Symbol	Min	Typical	Max	
Luminous flux <sup>(1)</sup>	Φ <sub>v</sub> <sup>(2)</sup>	45	50		lm
Dominant Wavelength (3)	Wd	585		595	nm
View angle (Lambertian)			150		
View angle (Lambertian II)	200		140		40.000
View angle (Focusing)	2Θ <sub>1/2</sub>		75		degree
View angle (Batwing)			140		
Forward Voltage (4)	VF	2.0		3.0	V
Power dissipation	P <sub>D</sub>	0.7		1.05	W





# HMHP-E1LG · HMHP-E1FG · HMHP-E1BG · HMHP-E1HG

Characteristics at  $I_F = 350 \text{mA} (Ta=25^{\circ}\text{C})$ :

Parameter	Crossb ol		Unit		
rarameter	Symbol	Min	Typical	Max	
Luminous flux <sup>(1)</sup>	Φ <sub>v</sub> <sup>(2)</sup>	80	90		lm
Dominant Wavelength (3)	Wd	515		535	nm
View angle (Lambertian)			165		
View angle (Lambertian II)			150		
View angle (Focusing)	2Θ <sub>1/2</sub>		70		degree
View angle (Batwing)			140		
Forward Voltage (4)	VF	3.0		4.0	V
Power dissipation	P <sub>D</sub>	1.05		1.4	W

# <u>HMHP-E1LB</u> · <u>HMHP-E1FB</u> · <u>HMHP-E1BB</u> · <u>HMHP-E1HB</u>

Characteristics at  $I_F = 350 \text{mA}$  (Ta=25°C):

Parameter	Crossb ol	Value			Unit
Parameter	Symbol	Min	Typical	Max	
Luminous flux <sup>(1)</sup>	Φ <sub>v</sub> <sup>(2)</sup>	20	23		lm
Dominant Wavelength (3)	Wd	460		475	nm
View angle (Lambertian)			165		
View angle (Lambertian II)	200		150		dograa
View angle (Focusing)	2Θ <sub>1/2</sub>		70		degree
View angle (Batwing)			140		
Forward Voltage (4)	VF	3.0		4.0	V
Power dissipation	P <sub>D</sub>	1.05		1.4	W



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### HMHP-E1LC

Characteristics at  $I_F = 350 \text{mA} \text{ (Ta=25}^{\circ}\text{C)}$ :

Donomoton	Crumb ol	Value			Unit
Parameter	Symbol	Symbol Min		Max	
Luminous flux <sup>(1)</sup>	Φ <sub>ν</sub> <sup>(2)</sup>	67	77		lm
Dominant Wavelength (3)	Wd	495		510	nm
View angle	2Θ <sub>1/2</sub>		165		degree
Forward Voltage (4)	VF	3.0		4.0	V
Power dissipation	P <sub>D</sub>	1.05		1.4	W

#### Note:

- 1. The typical luminous flux of Helixeon will be upgraded per season.
- 2.  $\Phi_v$ , minimum luminous flux performance guaranteed within published operating conditions. HELIO maintains a tolerance of  $\pm 10\%$  luminous flux measurements.
- 3. Dominant wavelength is derived from the CIE1931 chromaticity diagram and represents the perceived color. The tester tolerance of dominant wavelength is  $\pm 1$ nm.
- 4. HELIO maintains a tolerance of  $\pm 0.06$ V on forward voltage measurements.



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# **■** Absolute Maximum Ratings

Parameter	1W		
Peak Forward Current	500mA		
(1/10 Duty Cycle at 1KHz)	SOUNA		
Continuous Forward Current	350mA		
LED Junction Temperature	120°C		
Operation Temperature	-40°C ~+105°C		
Storage Temperature	-40°C ~+120°C		
Soldering Temperature	JEDEC 020c 260°C		
Allowable Reflow Cycles	3 Times		
ESD Sensitivity <sup>(1)</sup>	> 8,000V Human Body Model (HBM)		
ESD Sensitivity	Class 2 JESD22-A114-B		
Reverse Voltage (V)	not designed for reverse operation		

#### Note:

1. It is included the zener chip to protect the product from ESD.





# **■** Bin Code

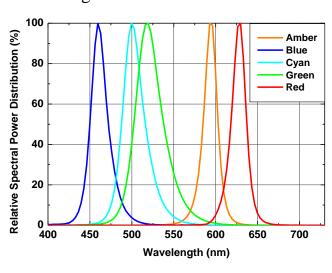
Color	Luminous flux (lm)	Rank (BIN)	Wavelength (nm)	Rank (BIN)
	30.6 - 39.8	Q0	610 - 620	A0
Red	39.8 - 51.7	R0	620 - 630	В0
	51.7 – 67.2	S0	630 - 640	C0
	30.6 - 39.8	Q0	585 - 587.5	A0
Amber	39.8 – 51.7	R0	587.5 - 590	В0
Amber	51.7 – 67.2	S0	590 - 592.5	C0
			592.5 - 595	D0
	51.7 – 67.2	S0	515 – 520	В0
	67.2 - 87.4	ТО	520 - 525	C0
Green	87.4 – 113.6	U0	525 - 530	D0
	113.6 – 147.7	V0	530 - 535	E0
			535 - 540	F0
	13.9 – 18.1	M0	460 - 465	E0
Blue	18.1 - 23.5	N0	465 - 470	F0
	23.5 – 30.6	P0	470 - 475	G0
	39.8 – 51.7	R0	490 - 495	A0
Cyan	51.7 – 67.2	S0	495 - 500	В0
			500 - 505	C0



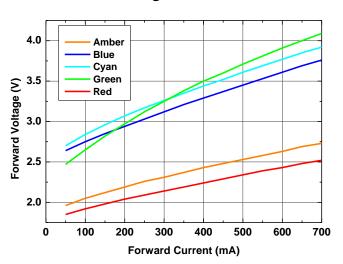


# **■** Optical & Electrical characteristics

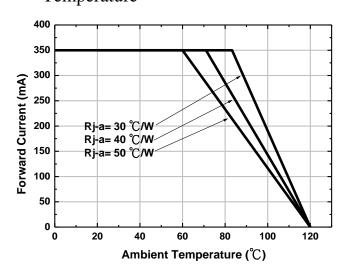
# Wavelength Characteristics



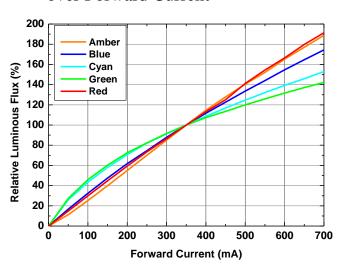
Forward Voltage vs Forward Current



Operating Current & Ambient Temperature



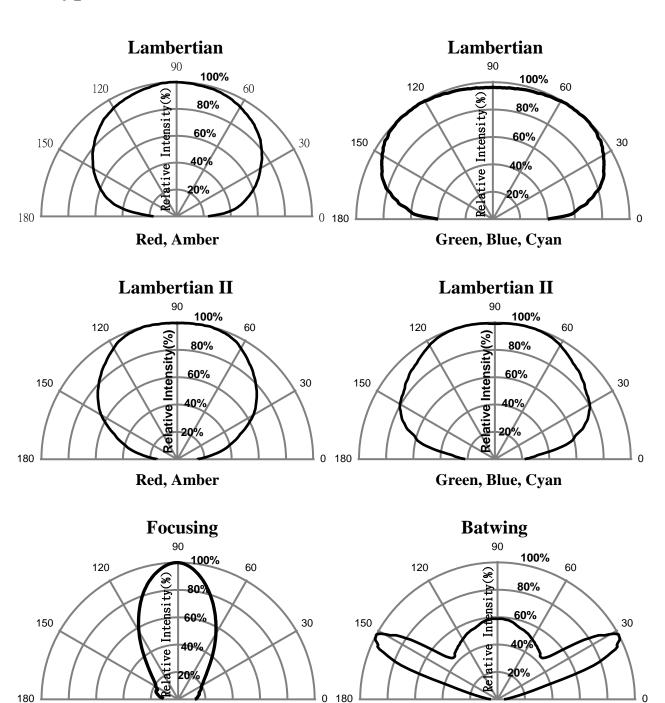
Typical Light Output Characteristics over Forward Current







# ■ Typical Polar Radiation Pattern



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Red, Amber, Green, Blue

Red, Amber, Green, Blue





# **■** Storage

- Do not open the moisture proof bag before the devices are ready to use.
- Before the package is opened, LEDs should be stored at temperatures less than 30°C and humidity less than 50%.
- After the package is opened, LEDs should be stored at temperatures less than 30°C and humidity less than 30%.
- LEDs should be used within 168 hours (7 days) after the package is opened.
- Before using LEDs, baking treatment should be implemented based on the following conditions: pre-curing at 60±5°C for 6 hours.

# **■** Handling Precaution

The softness and dust affinity of silicone molding lens constrain the handling of LED. Thus, some handling indications of HELIXEON emitters are presented for possible damage prevention and excellent reliability.

- Avoid leaving fingerprints or scratches (by sharp tools) on the silicone resin parts.
- Do not force over 2000gf impact or pressure on the silicone molding lens.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- When populating in SMT production, the pick-and-place nozzle must not place excessive pressure on the silicone molding lens.

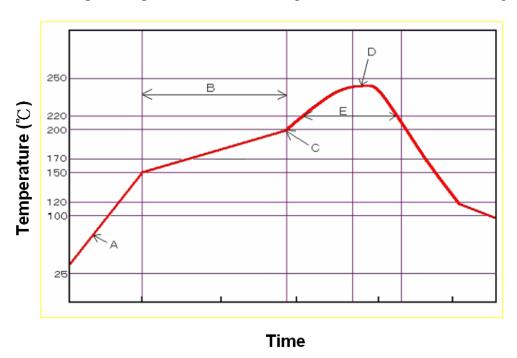






#### ■ Solder Reflow Process Parameters

Reflow soldering of Helixeon emitters requires effective control of heating and cooling. Both the rate of heating and cooling and the absolute temperatures reached are critical in assuring the formation of a reliable solder joint while avoiding damage to the emitter during the reflow process. The recommended temperature profile of solder reflow process is shown below in the figure.



#### 1. Preheat

- Set the temperature rising speed A at a rate of 2~4°C/s. Careful about rapid temperature rise in preheat zone as it may cause excessive slumping of the solder paste.
- Appropriate preheat time B will be from 60 to 180 seconds. If the preheat is insufficient, rather large solder balls tend to be generated. Conversely, if performed excessively, fine balls and large balls will generate in clusters at a time.
- Appropriate preheat ending temperature C will be from 180 to 200°C. If the temperature is too low, non-melting tends to be caused in the area with large heat capacity after reflow.

#### 2. Heating

- Careful about sudden rise in temperature as it may worsen the slump of solder paste.
- Set the peak temperature D in the range from 230 to 240°C.
- Adjust the melting time that the time over 220°C, E, will be from 30 to 90 seconds.

#### 3. Cooling

 Careful about slow cooling as it may cause the positional shift of parts and decline in joining strength at times.



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# **■** Reliability Test List

Test Item	Standard Test Method	<b>Test Conditions</b>	Note	Number of Damaged
Resistance to soldering heat (reflow soldering)	JEITA ED-4701 300 301	Ta=260°C, 10sec. (Pre treatment 25°C,70%,168hrs.)	2 times	0/10
Solderability (reflow soldering)	JEITA ED-4701 300 303	Tsld=215±5℃, 3sec. (Lead Solder)	1 time over 95%	0/10
Steady state operating life		$Ta{=}25^{\circ}\text{C}$ , $I_F=350mA$ Tested with Helio standard circuit board	1000 hrs.	0/10
Steady state operating life of high humidity heat		$60^{\circ}\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!$	1000 hrs.	0/10
Temperature cycle	JEITA ED-4701 100 105	-40°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min.	100 cycles	0/10
Thermal shock	JEITA ED-4701 300 307	0°C ~ 100°C 15sec. 15sec.	20 cycles	0/10
High temperature storage	JEITA ED-4701 200 201	Ta=100°C	1000 hrs.	0/10
Low temperature storage	JEITA ED-4701 200 202	Ta=-40°C	1000 hrs.	0/10
Vibration		2000 Hz, 2directions	60min.	0/10

#### Failure Criteria:

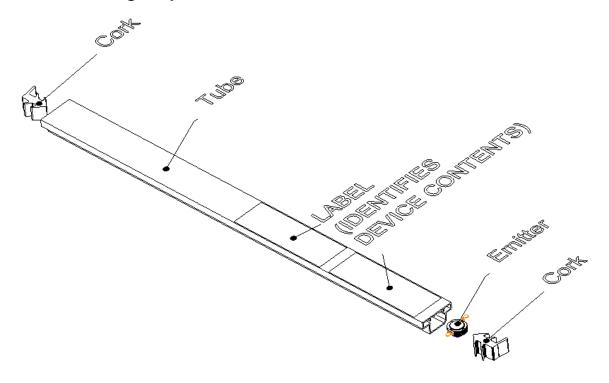
• Forward Voltage shift :> 200 mV

• Luminous Flux degradation :> 30 %

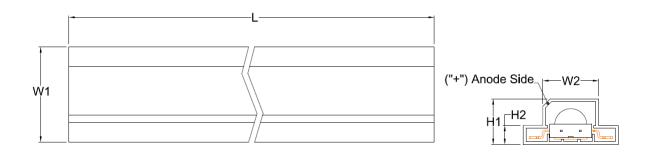
• Forward or Reverse Leakage : >10µ A



# ■ Tube Package Specifications



### **■** TUBE DIMENSIONS



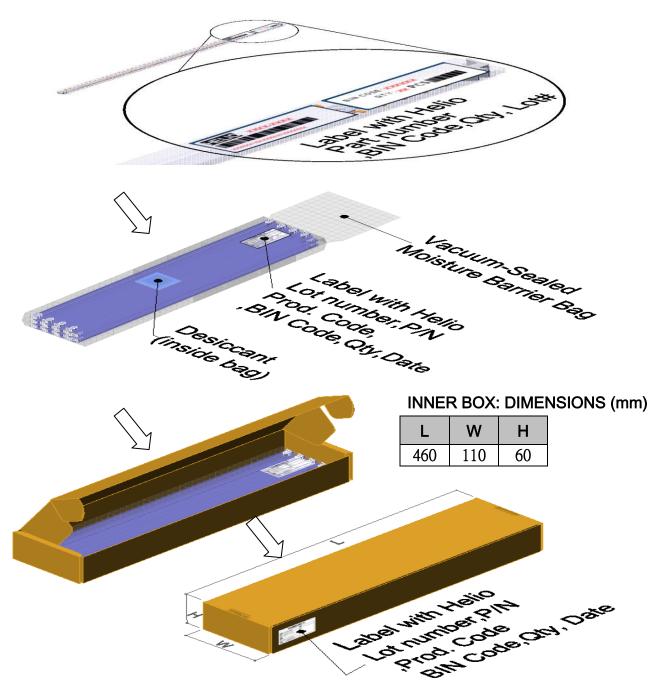
UNIT: mm

W1	W2	H1	H2	L
16.5	9.7	7.9	3.3	420.0
±0.2	±0.2	±0.2	±0.2	±1.0





# Packaging



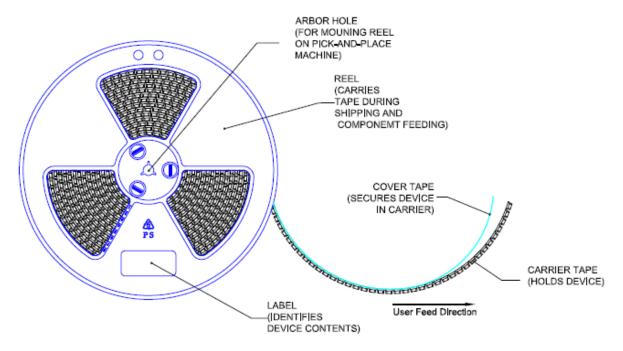
#### Note:

- 1. There are 50pcs emitters in a tube.
- 2. There are 20 tubes in an inner carton.

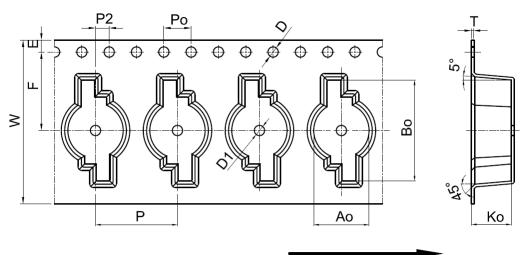




# Tape-and-Reel Package Specifications



### ■ CARRIER TAPE DIMENSIONS (2 PINS)



Feeding Direction

UNIT: mm

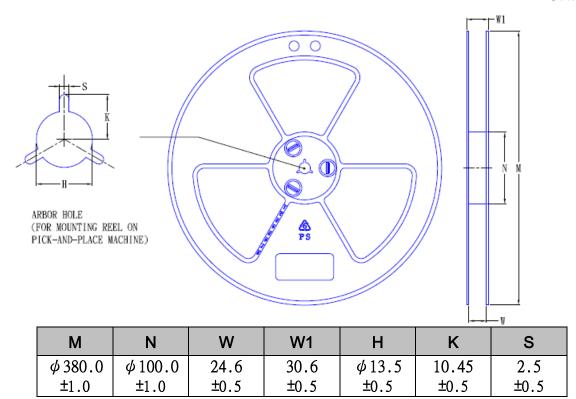
W	Ρ	ш	F	P2	D	D1	P0	A0	В0	K0	Т
							4.0 ±0.1				



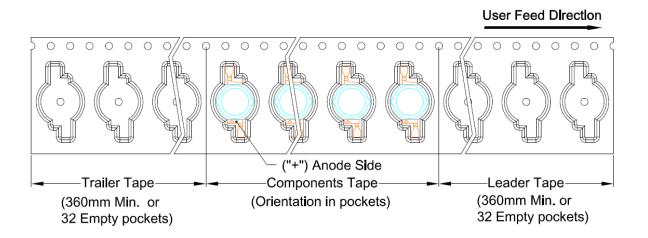


#### ■ REEL DIMENSIONS

UNIT: mm



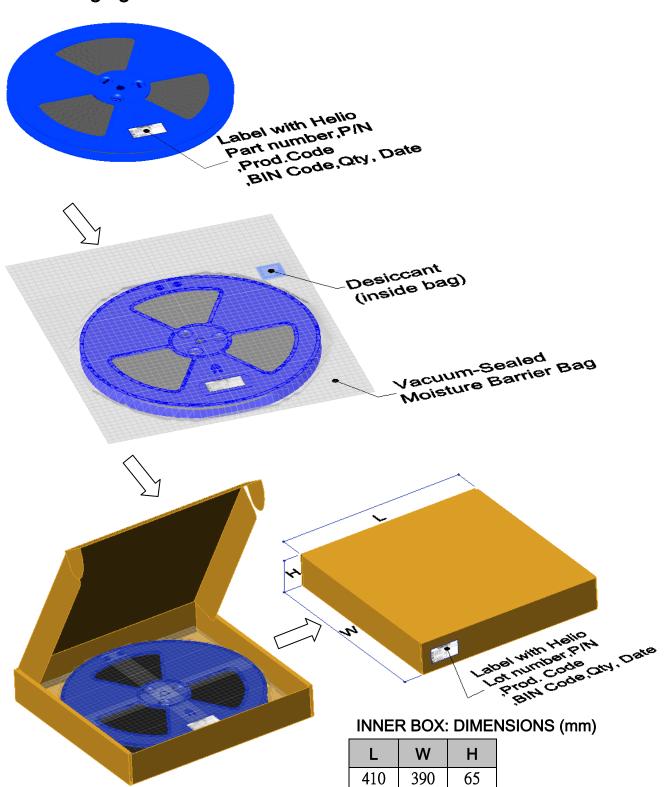
### ■ Leader/Trailer and Orientation(2 PINS)







# ■ Packaging



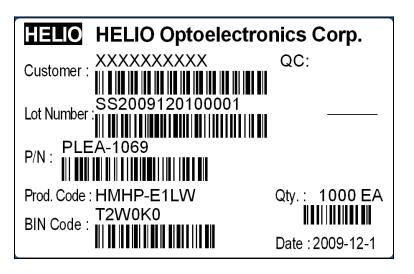


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### Bar code Label

#### **Label for Inner Carton**



# Label for Tube & Tray



BIN CODE: T2W0K0

QTY: 50 PCS